



Finite Difference Time Domain (FDTD) Electromagnetic Modeling Efforts of the ComPASS SciDAC (and related SBIR) Projects



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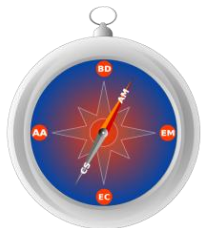
1. Tech-X Corp.
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Large Scale Computing and Storage Requirements for High Energy Physics (An HEP/ASCR/NERSC Workshop)

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Sciences via the SBIR program; used NERSC supercomputing center.





Motivating Science & Applications

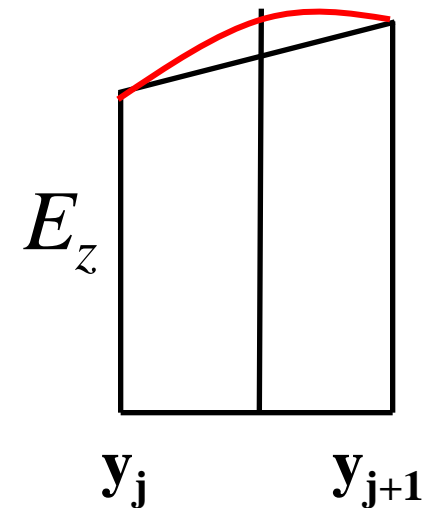
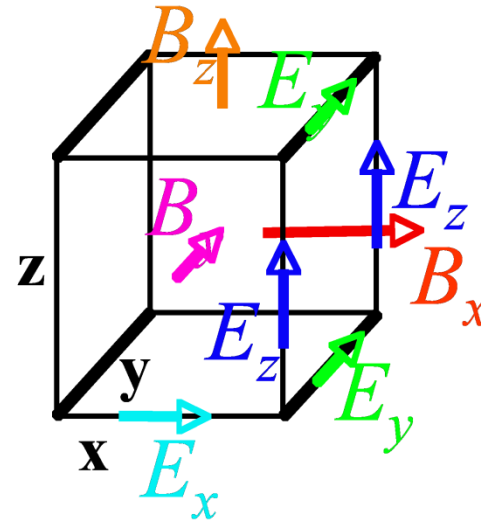


- Supporting multiple NERSC projects:
 - Community Petascale Project for Accelerator Science and Simulation
 - Particle simulation of laser wakefield particle acceleration
 - Simulation of photonic crystal structures for laser driven particle acceleration
- Scientific objectives for the next 3-5 years: rapid high-fidelity simulation & design of a wide range of accelerating structures
 - Superconducting radio-frequency (SRF) accelerating cavities
 - calculation of frequencies, Q's, modes (fundamental & high-order); surface heating
 - multipacting – move from analysis to designs that mitigate the problem
 - DOE/HEP applications include LHC, Project X, ILC
 - Normal conducting (warm) RF cavities and waveguides
 - breakdown – move from analysis to designs that mitigate the problem
 - simulate “magnetic insulation” of novel RF cavities for muon acceleration
 - DOE/HEP applications include muon collider, RF power transport, CLIC-like concepts
 - Dielectric structures (advanced concepts)
 - high-gradient, laser-driven photonic band gap (PBG) accelerating cavities
 - novel, larger-scale RF structures with ultra-high Q, ultra-low wakefields
 - Multi-physics capabilities are required, especially surface physics
 - coupling electromagnetics to surface heating & heat transport
 - electron-wall interactions



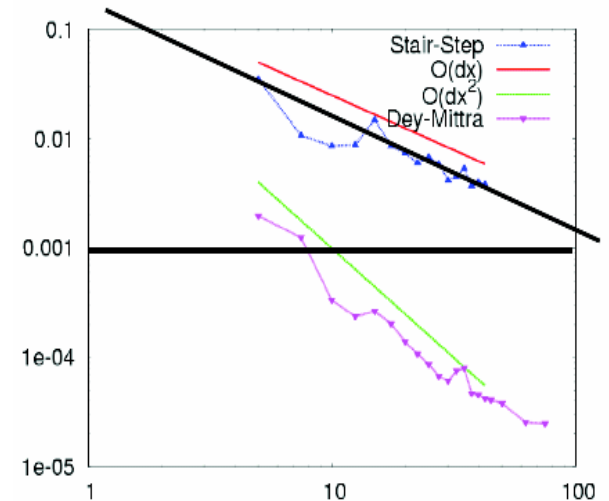
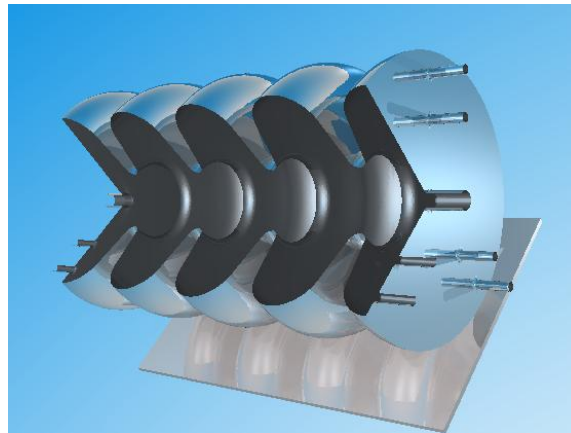
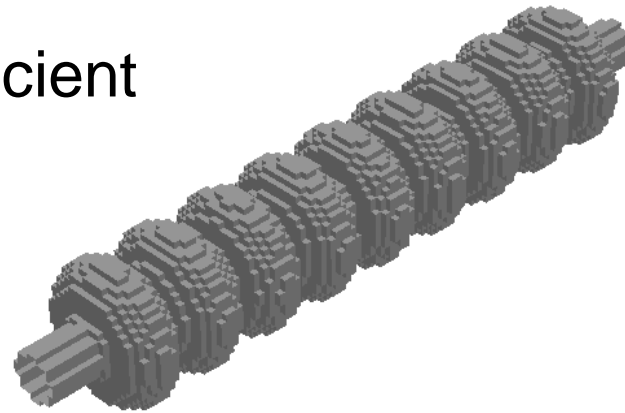
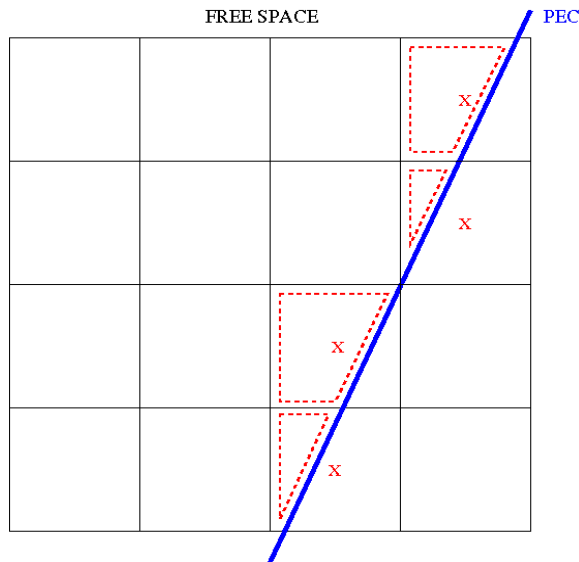
FDTD computations are based on the simple, fast Yee algorithm

- No matrix inversions
- Manifestly stable
 - Symmetric update matrix
- Works well with particles (PIC)
 - The choice of PIC codes
- Parallelizes well
 - Only boundary information exchanged between domains
 - Higher-order versions exist



Curved structures accurately modeled with embedded boundaries

- Stairstep was not accurate
- Dey-Mittra found to give sufficient accuracy

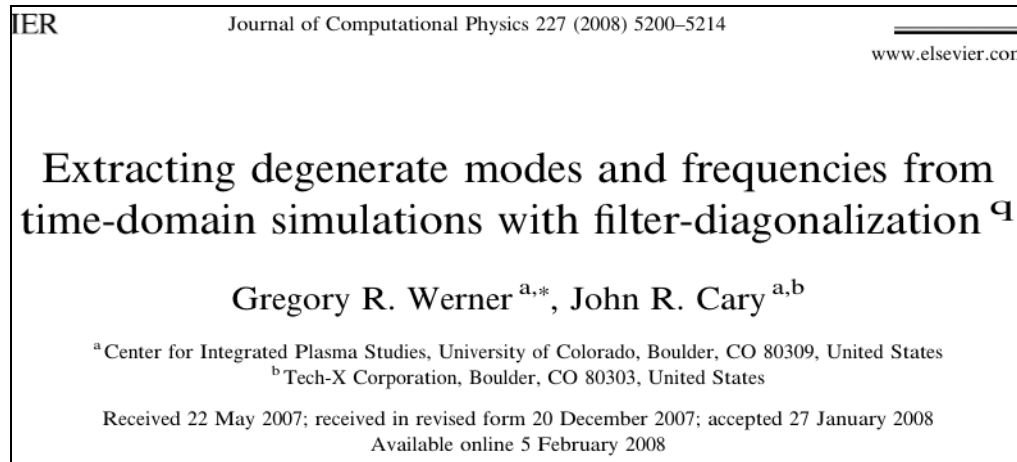




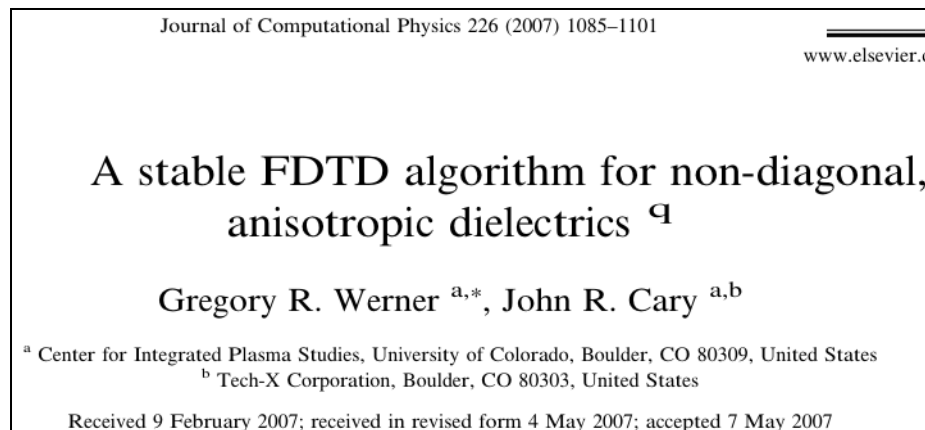
Improved algorithms are being developed



- *Broadly filtered diagonalization method:*



- *Symmetric dielectric update algorithms:*



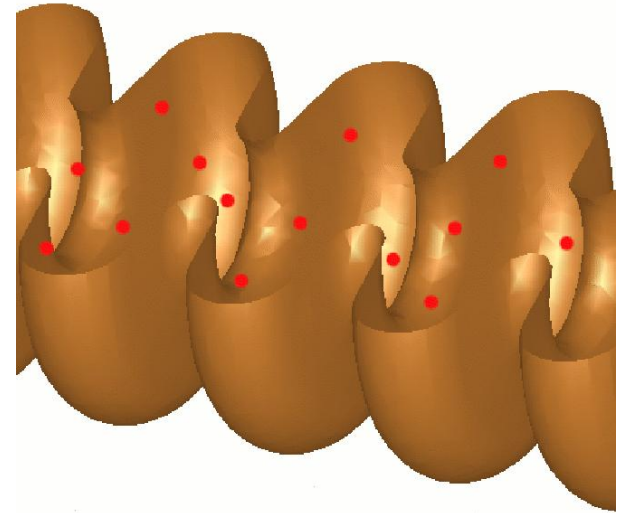


Broadly filtered diagonalization: time-domain codes become frequency domain



- Traditional method to obtain frequencies from time-domain codes:

- Excite one mode with narrow band
- Measure FFT peak or zero crossing
- Cannot distinguish degeneracies



- Broad filtering

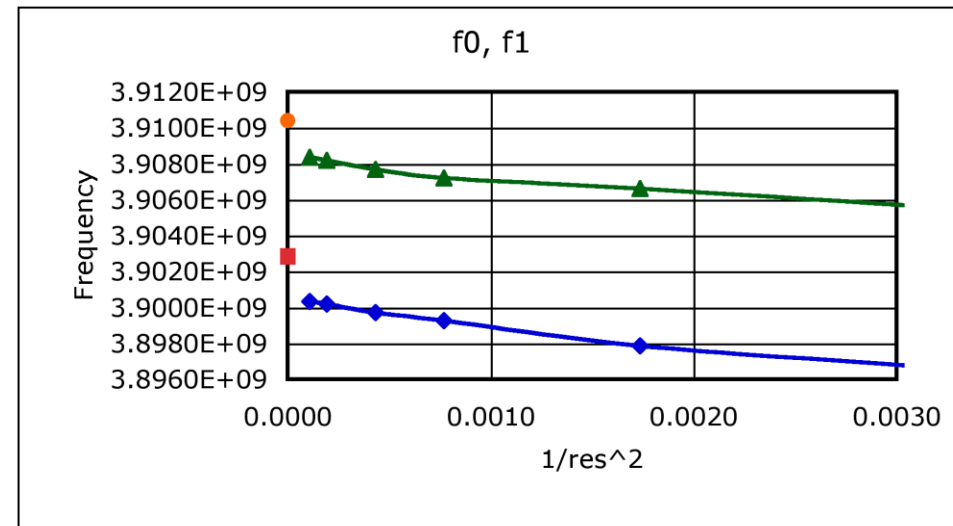
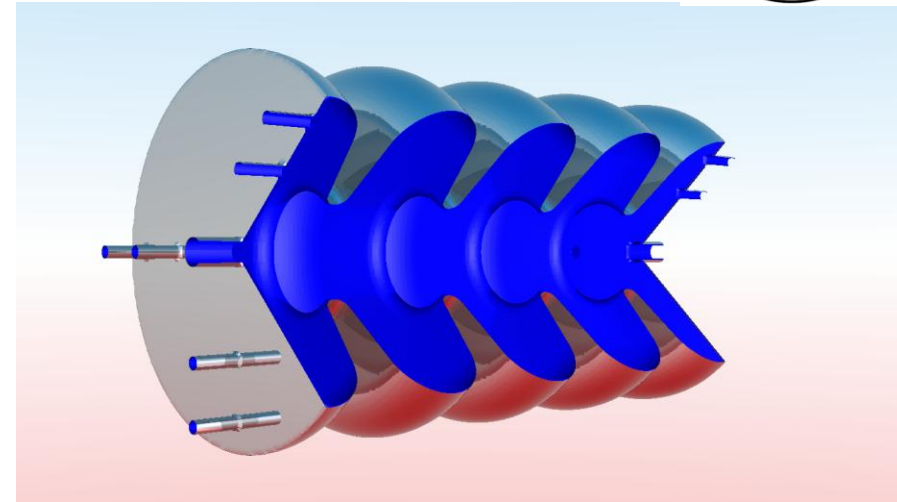
- Excite collection of modes in a frequency band
- Collect data on a subspace
- One application of operator gives small relative eigenvalue problem
- Singular value decomposition determines the linearly independent subspace
- Degeneracies found

Eliminates requirements for retention of multiple eigenvectors for eigenvalue solving



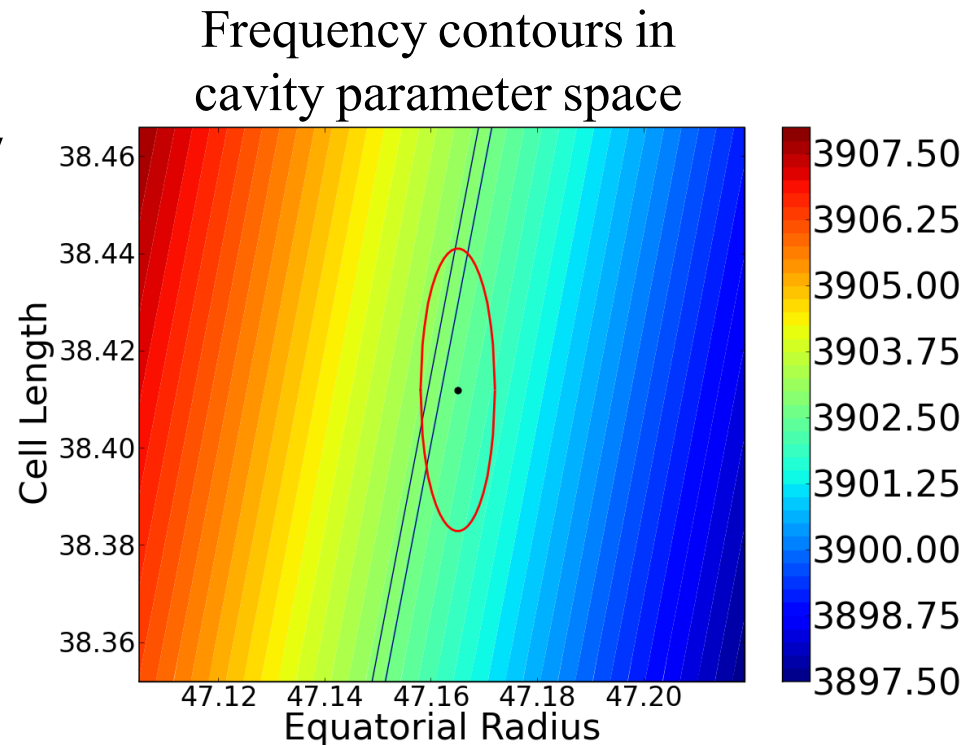
Validation with Experimental SRF Cavity Measurements have been Successful

- Collaboration with Fermilab
- A15 cavity for Kaon separator
 - Previous computations:
 - gave frequencies low by 5 MHz out of 4 GHz.
 - VORPAL computations (improved algorithm, parallel):
 - low by 2 MHz
 - verified against exact solutions
- Many attempts to understand discrepancy:
 - Model no holes? one? all?
 - Correct for dielectric of air?



A15 cavity validation study with Fermilab identified error in previous measurements

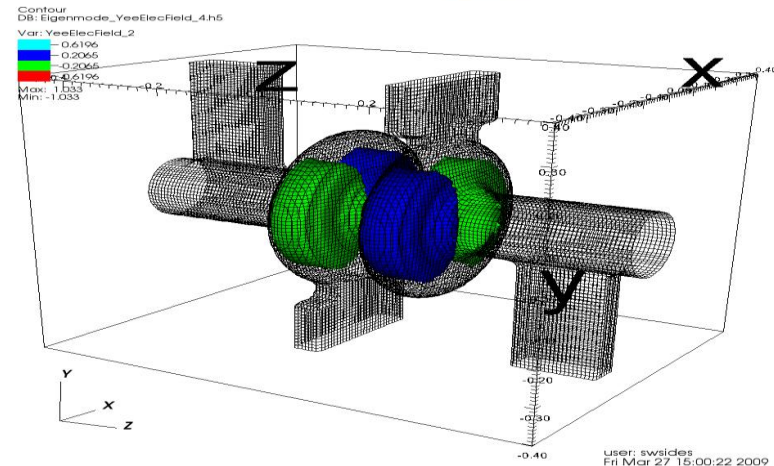
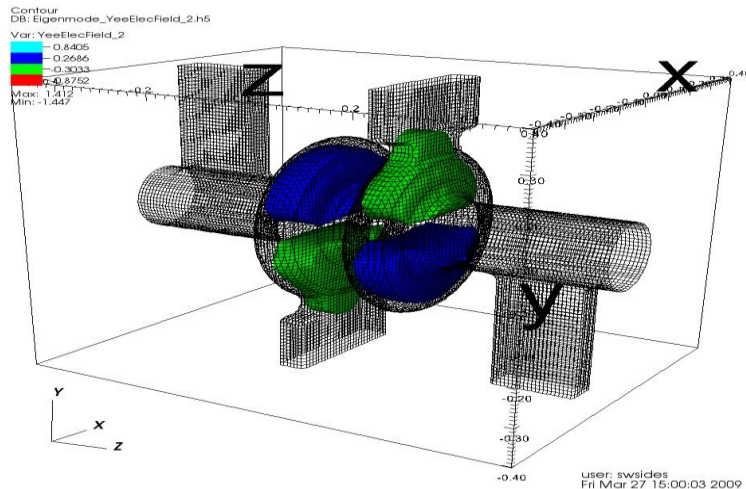
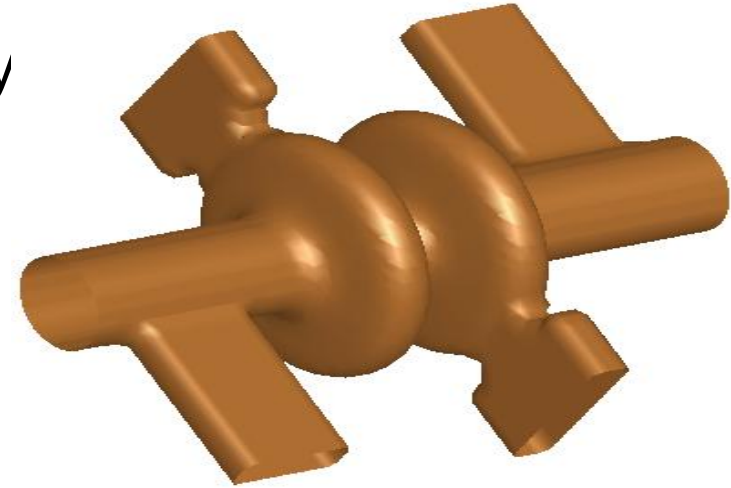
- Reduce the equator radius by 0.001 inch
- Get agreement
- Ask designers to measure their cavities
- CORDEX (+ calipers) show error in cavity dimensions
- Corrected model agrees well with computation.



Overlap of dimensional error ellipse
with computational and experimental
frequency uncertainty shows validation

Multipactoring determines field limits in crab cavities

- LHC upgrade: introduce crab cavity to improve luminosity
- Jlab/Cockcroft splitting from waveguide replacement



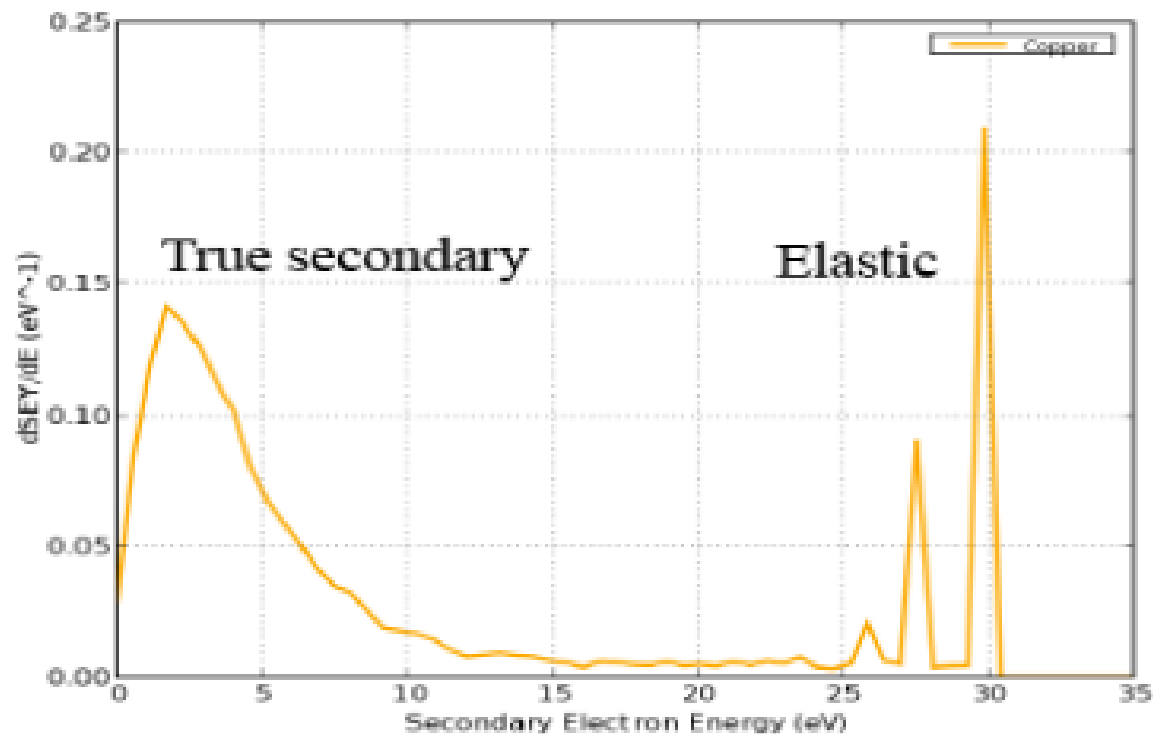
G. Burt, J. Smith (Cockcroft Institute)

H. Wang, K. Tian, R. Rimmer (Jefferson Lab)



VORPAL's secondary electron emission models allow realistic multipacting studies

- Simple secondary emission – one secondary emitted at normal incidence
- Phenomenological model – true, diffuse and elastic secondaries
- M. A. Furman and M. Pivi, Phys. Rev. ST Accel. Beams 5, 124404 (2002)

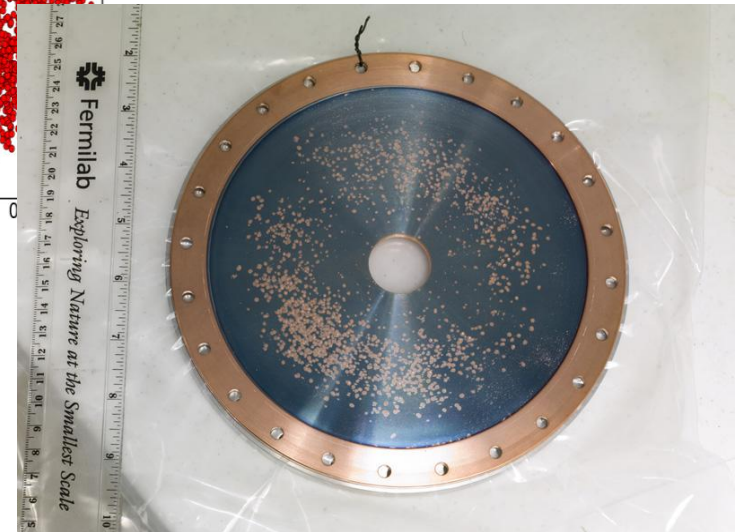
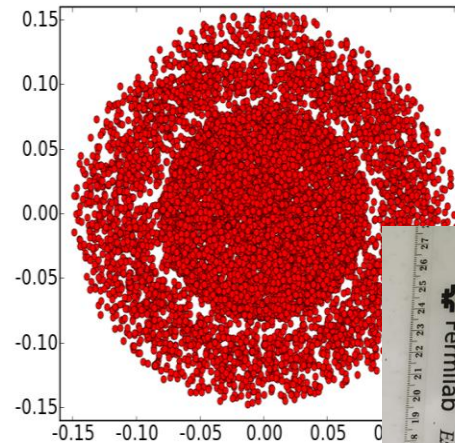
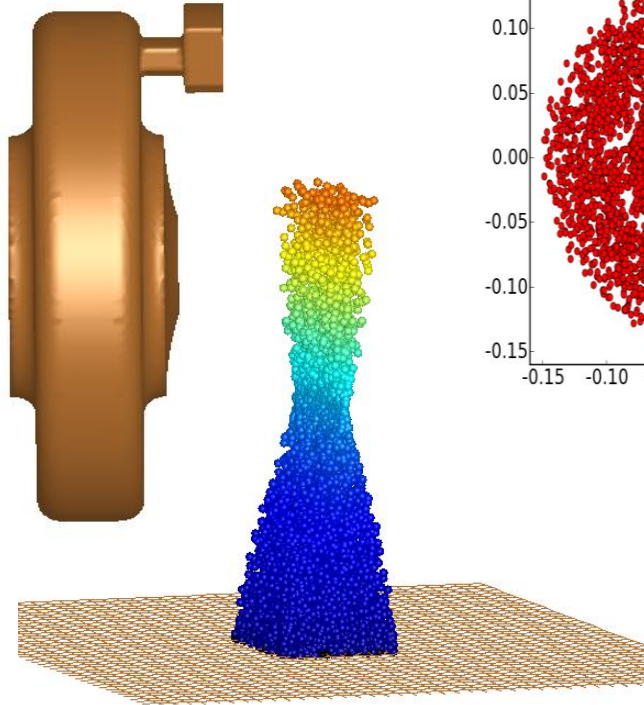
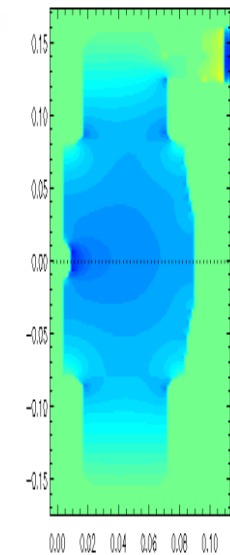


Available as 'txphysics' at <http://www.txcorp.com/products/TxPhysics/>
Library funded under SBIR. Made available in SciDAC codes.





Multipacting analysis capability used to evaluate high-gradient muon collider cavities



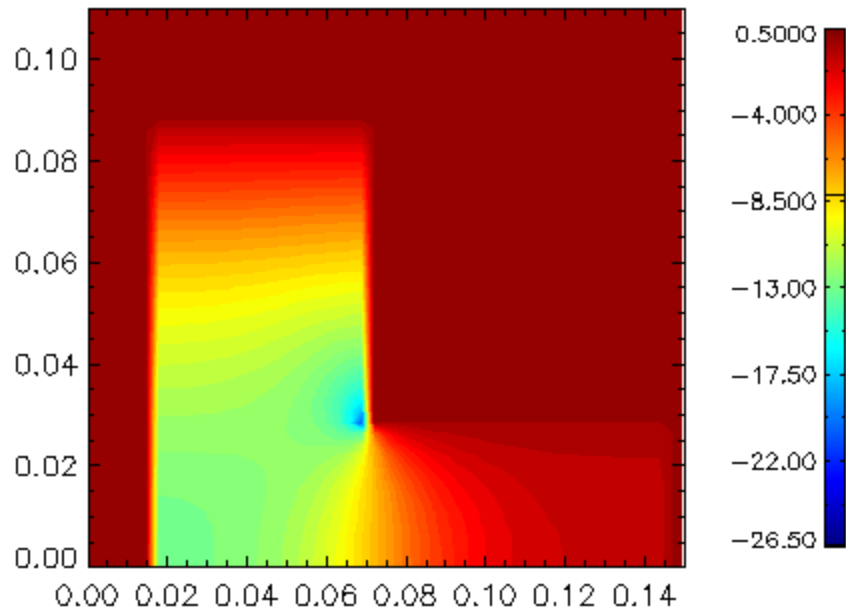
- VORPAL has accurate field models and physics-based surface emission algorithms (right)
- Multipacting and breakdown often coincident. Simulation shows multipacting where experiment shows breakdown.



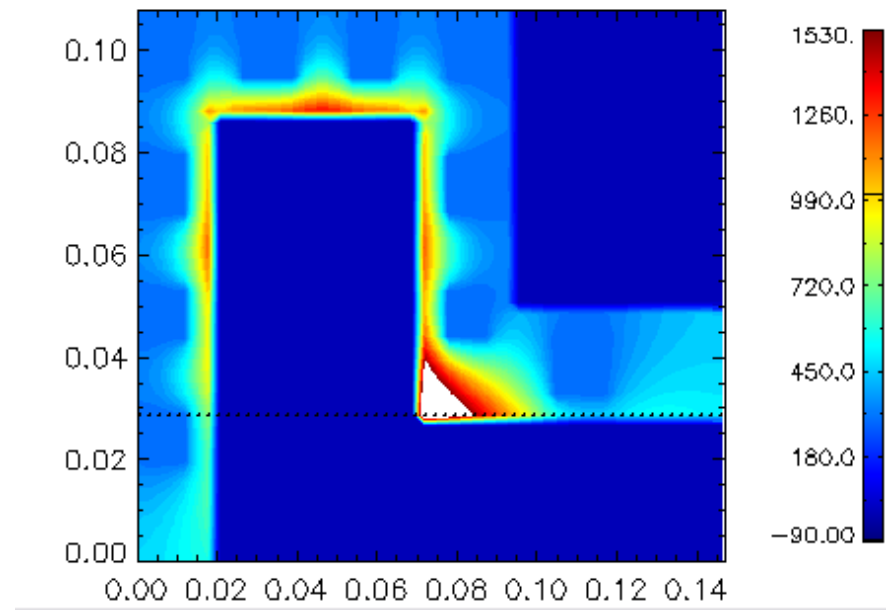


Developing new multi-physics capabilities: combined EM & heat flow

- Simplified RF photocathode 'electron gun', with 10 coolant channels.
- EM and thermal updates proceed simultaneously in VORPAL
- Ohmic wall losses are communicated between EM and Thermal.
- The thermal timescale is artificially reduced to match the EM time-scale.
- R_s , k , and C are temperature dependant, e.g., non-linear.



EM: E_z Electric Field



Thermal: Temperature



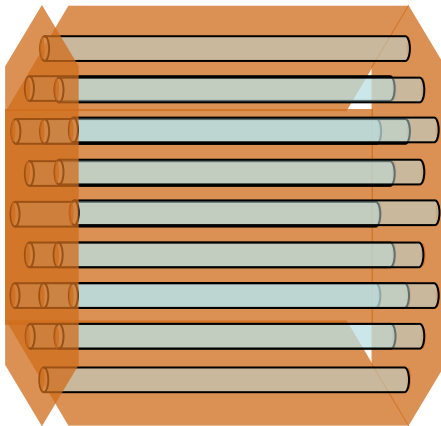
VORPAL is successfully modeling dielectric accelerating structures

STUDY OF HYBRID PHOTONIC BAND GAP RESONATORS FOR PARTICLE ACCELERATORS

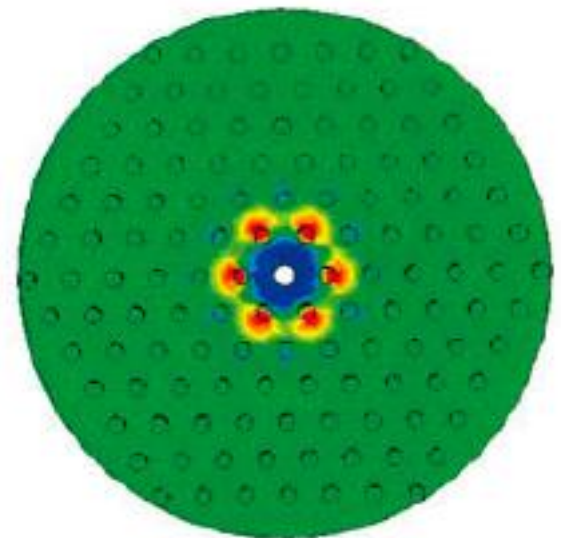
M. R. Masullo,¹ A. Andreone,² E. Di Gennaro,² S. Albanese,³
F. Francomacaro,³ M. Panniello,³ V. G. Vaccaro,³ and
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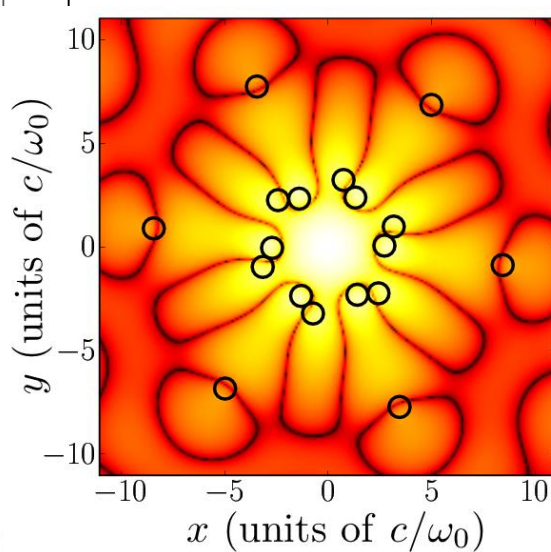
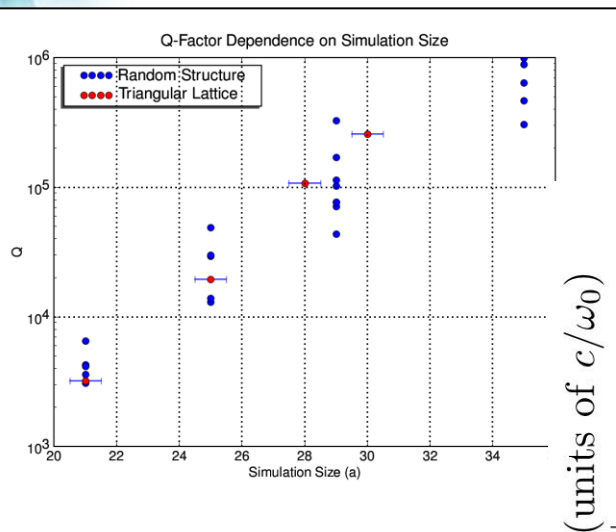
room temperature confirm the monomodal behavior, but the Q value is lower than expected (roughly 10^3). This is mainly due to



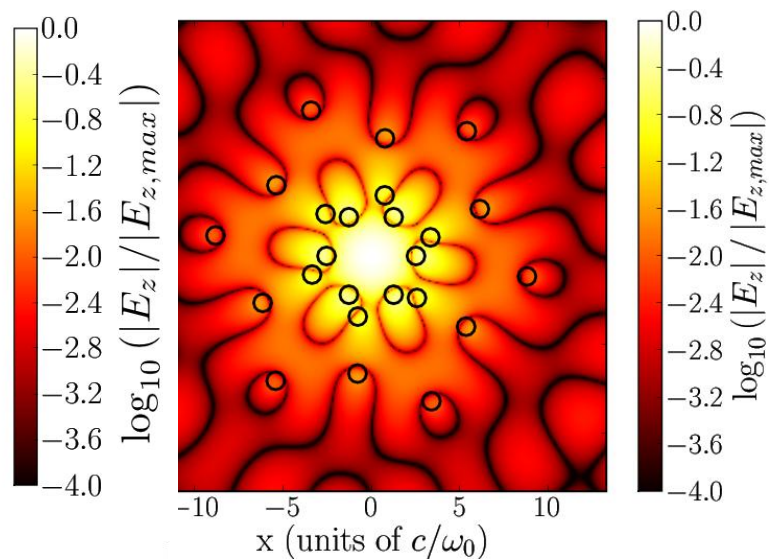
- 5 layers of (147) dielectric cylinders, yet $Q \sim 10^3$



Our optimizations found asymmetric systems with many fewer rods, yet larger Q (quality factor)



Final: Q ~ 11,000



Final: Q ~ 100,000

- Computations showed that symmetry breaking critical





Current HPC Requirements



- Architectures: ATLAS (LLNL), Franklin (NERSC), NY Blue (BNL), Intrepid (ALCF), Jaguar (ORLCF)
- Compute/memory load for typical production runs
 - 1-10 million cells; $< 100,000$ time steps
 - $> 2 \times 10^6$ cells/s; $\sim 1,000$ cores; < 100 MB/core
 - Efficient use of 16,000 cores shown; $\sim 1,000$ cells per core
- Data read/written
 - 3 to 9 doubles per cell \rightarrow $< \text{GB}$ files; ~ 50 dumps per run
 - particle data is highly variable
- Necessary software, services or infrastructure
 - parallel I/O support for HDF5
 - 3D viz (i.e. Visit server on Franklin)
- Current primary codes and their methods or algorithms
 - VORPAL, Cartesian mesh, FDTD
- Known limitations/obstacles/bottlenecks
 - I/O scaling



Broad usage at NERSC & LCFs



- VORPAL openly available to DOE collaborators at NERSC (Franklin), ALCF, ORLCF (Jaguar)
- Large number of users
 - 30 at NERSC under 5 different projects (repos)
 - 5-10 at ALCF under 2 different projects
- Large number of hours
 - NERSC: 6M hrs 2008, 2M by mid March for 2009
 - ALCF: 15M hrs 2008, 5M by mid March for 2009
- High concurrency (routine use at high processor counts)
 - NERSC, 2009: 8656 for average job
 - ALCF, 2009: 8192 cores typical
- Thanks to Katie Antypas of NERSC for data





HPC Usage & Methods; next 3-5 Years

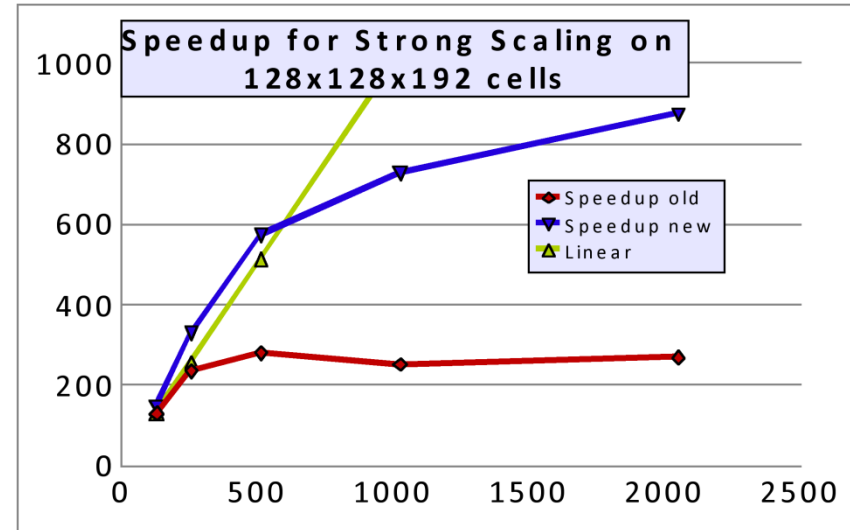


- Upcoming changes to codes/methods/approaches
 - implicit solvers; higher-order solvers (implicit and/or explicit);
 - coupling solvers for multiphysics (heat in wall, EM in vacuum);
 - improved on-the-fly data reduction to reduce/control I/O
 - single-core performance improvements; SIMD, single-precision
 - multiple grids; sophisticated static domain decomposition
- Changes to compute/memory load
 - 10x to 100x increase in mesh – up to 10^9 cells
 - for higher-order, implicit – increase in memory, not in mesh
- Changes to Data read/written
 - always more space is desired; working to reduce/slow growth
- Changes to necessary software, services or infrastructure
 - database support for parameter scans & design studies
- Anticipated limitations/obstacles/bottlenecks on 1000K PE system
 - file I/O (e.g. rapid dump/restore); fault tolerance; easy/rapid viz
- Strategy for dealing with multi-core/many-core architectures
 - actively porting to GPU



Developing: improved messaging for parallel performance enhancement

- Improved messaging: send only what is needed for FDTD
- Allows use of domains with only 3000 cells (before, 64000 cells)
- Consequences:
 - Time to solution increases by 20x if resources are available
 - Smaller problems can be addressed with high-performance computation



Break in strong scaling at 1000
procs or 3000 cell domains

- 120M cells can take advantage of 40k procs

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TECH-X CORPORATION



Recent GPU Developments

- VORPAL FDTD Simulations can be run across multiple GPUs. Speedup observed for large domains.
- Efficient data structures will improve messaging between CPU↔GPU → better performance across multiple devices for smaller domains

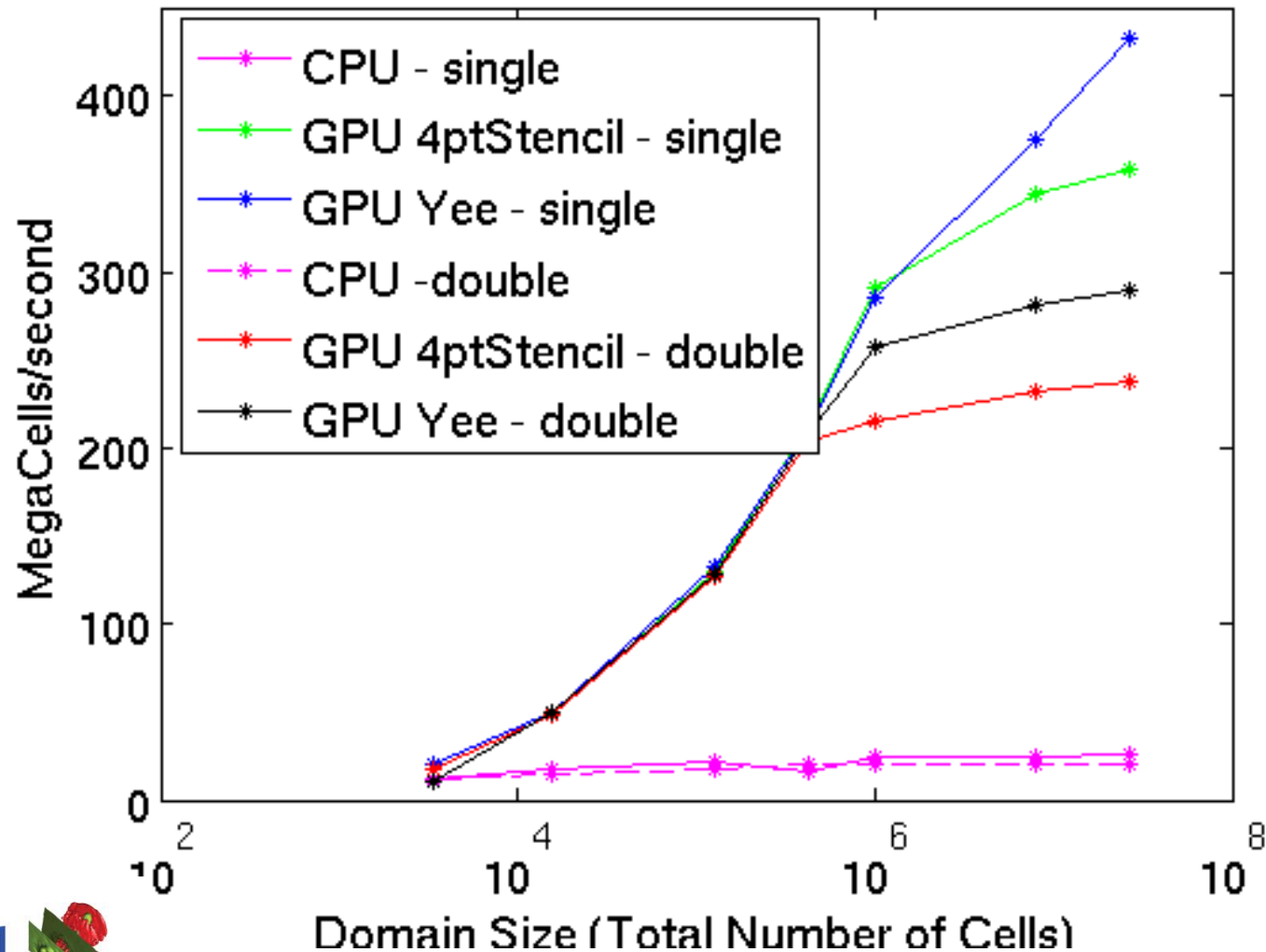
Future Work and Projections

- Dey-Mittra cut-cell algorithms will be implemented soon
→ highly resolved and efficient RF cavity simulations on a GPU.
- Move particle push onto GPU.
- Multi-GPU machines will
 - greatly accelerate current simulations or
 - enable more highly resolved simulations with greater fidelity
- GPUs are an energy-efficient, cost-effective tool for rapid plasma and EM simulations.



Timings: FDTD Performance on a single GPU or CPU

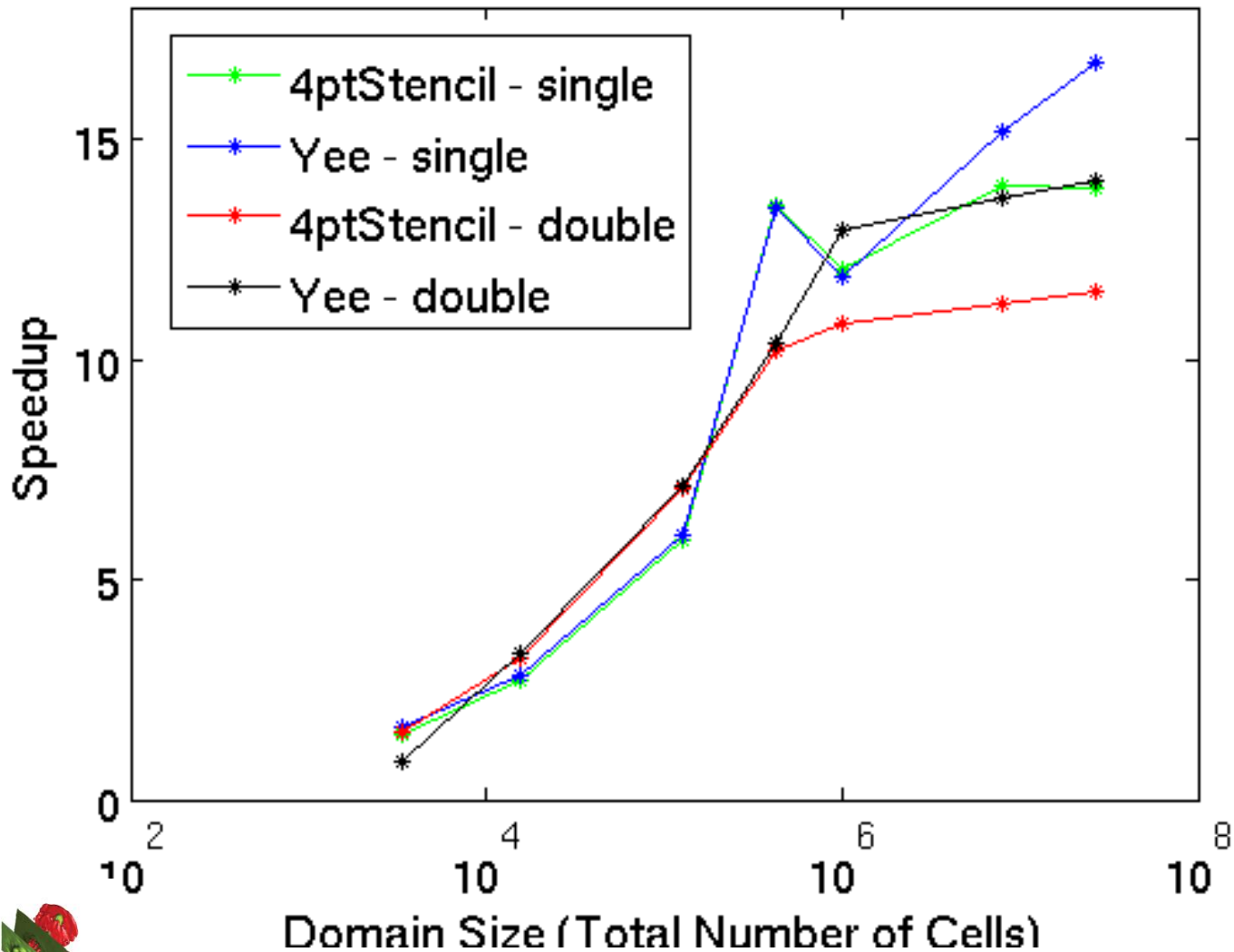
MegaCells/second in VORPAL : CPU vs GPU





Speedup of GPU kernels : 1 GPU vs 1 CPU

Speedup of VORPAL FDTD





Summary



- Recommendations on NERSC architecture, system configuration and associated service requirements needed for your science:
 - database support for parameter scans & design studies
 - support task-based parallelism, so that many large, parallel jobs can be executed (w/ optimizer?) for design of accelerators
 - primary viz support should target largest system (Hopper)
- What significant scientific progress could you achieve over the next 5 years with access to ~50X NERSC resources?
 - move from large, single run work flow to real design activities, including error analysis, to reduce cost & risk for future facilities
 - multi-physics EM modeling could yield smaller/cheaper accelerators:
 - understand multipactoring → high-gradient SRF cavities
 - understand RF breakdown → higher RF power availability
 - dielectric structure simulations could enable the development of fundamentally new accelerator hardware with much higher gradients